

<b>PATENT ASSIGNMENT COVER SHEET</b>
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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ABHISHEK KUMAR AGRAWAL	01/28/2021
HUIZHAO WANG	01/29/2021
PEIMAN AMINI	02/15/2021
SIGURD SCHELSTRAETE	02/03/2021
DEBASHIS DASH	02/10/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC
<b>Street Address:</b>	5005 E. MCDOWELL ROAD, MD A700
<b>City:</b>	PHOENIX
<b>State/Country:</b>	ARIZONA
<b>Postal Code:</b>	85008
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17664273
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(602)244-3169
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<b>ATTORNEY DOCKET NUMBER:</b>	ONS04086F1C01US
<b>NAME OF SUBMITTER:</b>	KELLY A. HALL
<b>SIGNATURE:</b>	/Kelly A. Hall/
<b>DATE SIGNED:</b>	05/20/2022
<b>Total Attachments: 6</b>	

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For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we,

Name	of (City and State OR Country)
Abhishek Kumar AGRAWAL	Fremont, CA
Huizhao WANG	San Jose, CA
Peiman AMINI	Fremont, CA
Sigurd SCHELSTRAETE	Menlo Park, CA
Debashis DASH	Newark, CA

agree to sell, assign, and transfer, and do hereby sell, assign, and transfer to Semiconductor Components Industries, LLC, a limited liability company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives ("SCI"), the entire right, title, and interest in and to the inventions and discoveries as described, illustrated, and/or claimed in

**Title: FLEXIBLE DISTRIBUTED ANTENNA ARRAY**  
**Attorney Docket No.: ONS04086F1US**  
**Serial No.: 17/176547**  
**Filing Date: February 16, 2021**

together with the entire right, title, and interest in and to the above listed application(s), and in and to any and all provisional, non-provisional, divisional, continuation, continuation-in-part, international, foreign, and any and all other applications related thereto, and also including any and all grants, issuances, letters patent, reissues, reexaminations, renewals, priority rights, and priority claims related to any of the foregoing, and any and all rights to collect past damages for infringement of any of the foregoing (the "Patent Rights").

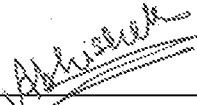
We further authorize SCI to apply for and hold and maintain the Patent Rights throughout the world directly in its own name or any other name which SCI deems appropriate in its sole discretion, and to claim the priority of the filing date of the above listed application(s).

We agree that, when requested, we will, without charge to SCI, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing, maintaining, and enforcing the Patent Rights in any and all countries and for vesting title thereto in SCI or its nominees.

We represent and warrant that we have full right to convey the entire right, title and interest herein sold, assigned, and transferred, and that the Patent Rights hereby conveyed are free from all prior assignment, grant, mortgage, license, or other encumbrance to anyone other than SCI. We covenant and further warrant that we will not convey hereafter any part of the Patent Rights to anyone other than SCI or do any act whatsoever conflicting with this ASSIGNMENT & AGREEMENT.

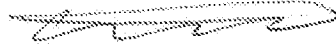
We hereby authorize SCI or anyone it may properly designate to insert in this ASSIGNMENT & AGREEMENT the filing date and serial number of the above listed application(s) when ascertained. More than one counterpart of this ASSIGNMENT & AGREEMENT may be executed, each of which will be deemed an original.

By (Inventor signature):




Abhishek Kumar AGRAWAL

Signed on this 28 day of Jan, 2021  
day month year

By (Inventor signature):   
\_\_\_\_\_

**Huizhao WANG**

Signed on this 29 day of January, 2021  
day month year

By (Inventor signature):  \_\_\_\_\_  
Peiman AMINI

Signed on this 15 day of Feb, 2021  
day month year

By (Inventor signature):  \_\_\_\_\_  
Sigurd SCHELSTRAETE

Signed on this 3 day of FEBRUARY, 2020  
day month year

By (Inventor signature): *Debashis Dash*  
**Debashis DASH**

Signed on this 10 day of February, 2021  
day month year